



SOLID STATE INC.

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2N4150

**NPN SILICON
HIGH POWER
TRANSISTORS**

DIFFUSED SILICON PLANAR PASSIVATED TRANSISTORS

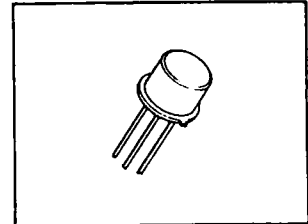
These devices are designed for use in high current switching applications. The latest technologies are used to offer the highest degree of reliability.

FEATURES

- Low Saturation Voltage
- Fast Switching
- Collector Current: 10 Amps Peak
- Low Leakage Current
- Low Drive Requirement

APPLICATIONS

- High Speed Switching
- Regulated Power Supplies
- Converters
- Inverters
- Wide Band Amplifiers



ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures

Storage Temperature -65°C to 200°C
Operating Junction Temperature $+200^{\circ}\text{C}$
Lead Temperature (soldering, 60 second time limit) $+300^{\circ}\text{C}$

Maximum Power Dissipation

Total Dissipation at 100°C Case Temperature **5 Watts**
(1) See Safe Operating Curves for derating
Linear derating factor **$50\text{ mW}/^{\circ}\text{C}$**

Maximum Voltages and Current

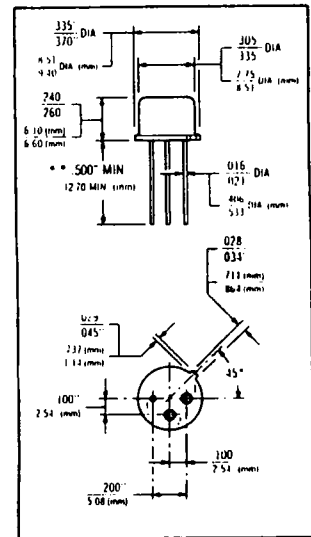
V_{CEO} Collector to Emitter Voltage **80 Volts**
 V_{CBO} Collector to Base Voltage **100 Volts**
 V_{EBO} Emitter to Base Voltage **5 Volts**
 I_C Continuous Collector Current **10 Amps**

MECHANICAL CHARACTERISTICS

Case: **TO-39**

Leads:

1. Emitter
2. Base
3. Collector



*ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}\text{C}$ unless otherwise noted)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	2N4150		UNITS
			MIN	MAX	
Collector Cutoff Current	I_{CEO}	$V_{CE}=60\text{V}, I_B = 0$		10	μAmp
Collector Cutoff Current	I_{CEX}	$V_{CE}=100\text{V}, V_{EB} = 0.5\text{V}$		10	μAmp
Collector Cutoff Current	I_{CBO}	$V_{CB}=60\text{V}, V_{BE} = 0\text{V}$		0.1	μAmp
Emitter Cutoff Current	I_{EBO}	$V_{BE}=5\text{V}, V_{CE} = 0\text{V}$		10	μAmp
†DC Current Gain	h_{FE}	$I_C = 5\text{A}, V_{CE} = 5\text{V}$	40	120	
		$I_C = 10\text{A}, V_{CE} = 5\text{V}$		10	
		$I_C = 1\text{A}, V_{CE} = 5\text{V}$		50	
Collector to Base Breakdown Voltage	BV_{CBO}	$I_C = 10\mu\text{A}, I_E = 0$	100		Volts
Collector to Emitter Breakdown Voltage	BV_{CEO}	$I_C = 0.1\text{A}, I_B = 0$	70		Volts
Emitter to Base Breakdown Voltage	BV_{EBO}	$I_E = 10\mu\text{A}, I_C = 0$	5		Volts
† Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 5\text{A}, I_B = 0.5\text{A}$		0.6	Volts
		$I_C = 10\text{A}, I_B = 1\text{A}$		2.5	Volts
† Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 5\text{A}, I_B = 0.5\text{A}$		1.5	Volts
		$I_C = 10\text{A}, I_B = 1\text{A}$		2.5	Volts

* JEDEC registered data † Pulse conditions: Width = $300\mu\text{s}$; Duty Cycle $\leq 2\%$ (measured using Kelvin connections)

DYNAMIC CHARACTERISTICS*

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	2N4150		
			MIN	MAX	
Pulse Delay Time	t_d	See Circuit #1		—	nSec
Pulse Rise Time	t_r	See Circuit #1		200	nSec
Pulse Storage Time	t_s	See Circuit #1		2.0	μ Sec
Pulse Fall Time	t_f	See Circuit #1		200	nSec
Collector Base Capacitance	C_{obo}	$V_{CB} = 10V, I_E = 0, f = 1 \text{ MHz}$		350	pF
High Frequency Small Signal	$ h_{fe} $	$I_C = 200mA, V_{CE} = 10V, f = 10MHz$	1.5		

*JEDEC registered data.

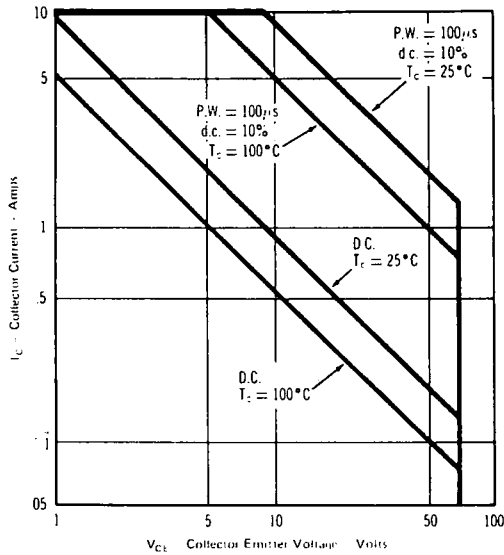


Figure 1—Maximum Safe Operation Region

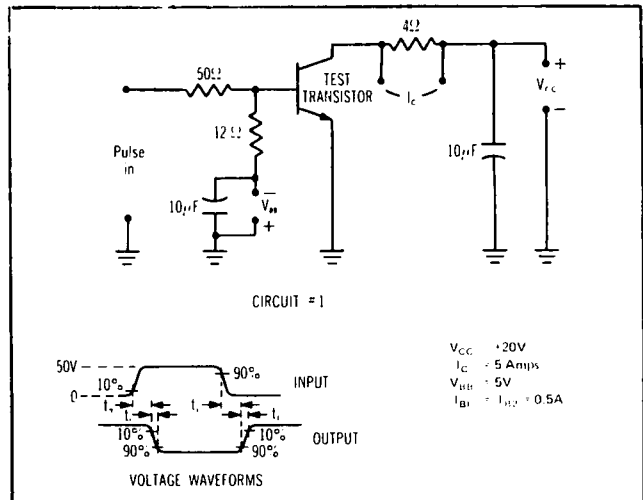


Figure 2—Pulse Response Measurement Circuit

TYPICAL CHARACTERISTICS

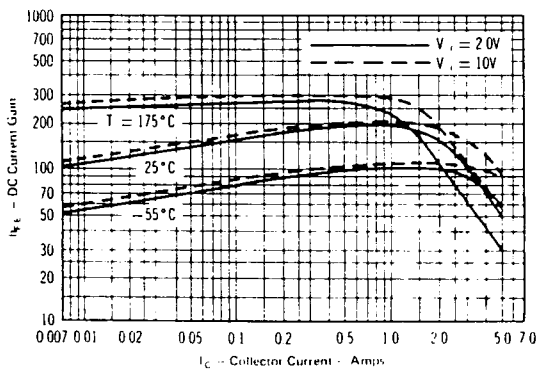


Figure 3—Static Forward Current Transfer Ratio

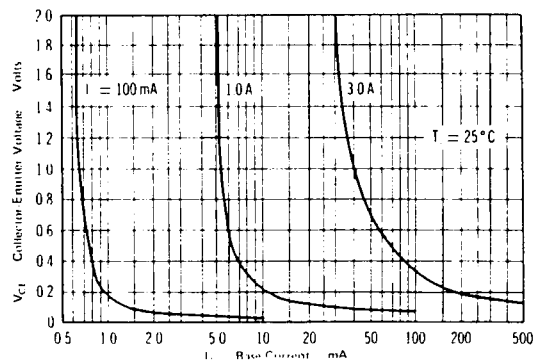


Figure 4—Collector Saturation Region